

△ 0.10 C

ę

oʻ

10

-D2

 $(k1)^{-1}$

(k2)

e4

L2e2 (14X ę

В

____O.10 C 2X

SEE DETAIL A

-L4 (15X)

—b(34X) ⊕0.10₩CAB

26

27

17

TOP VIEW

FRONT VIEW

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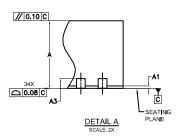


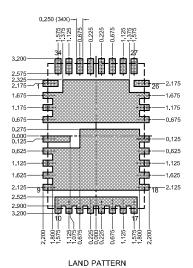
PIN#1

INDICATOR

LQFN34 4x6, 0.45P CASE 487AB ISSUE C







*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

RECOMMENDATION

NOTES: UNLESS OTHERWISE SPECIFIED

- A) DOES NOT FULLY CONFORM TO JEDEC REGISTRATION MO-220, DATED MAY/2005.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
 C) DIMENSIONS DO NOT INCLUDE BURRS
 OR MOLD FLASH. MOLD FLASH OR
 BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.

	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
Α	1.20	1.30	1.40	
A1	0.00	0.03	0.05	
A 3	0.17	0.22	0.27	
b	0.20	0.25	0.30	
D	3.90	4.00	4.10	
D1	3.40	3.50	3.60	
D2	0.90	1.00	1.10	
D3	3.40	3.50	3.60	
D4	2.60	2.70	2.80	
Е	5.90	6.00	6.10	
E1	2.40	2.50	2.60	
E2	1.65	1.75	1.85	
e1	0.450 BSC			
e1/2	0.225 BSC			
e2	0.500 BSC			
e3	0.675 BSC			
e4	0.125 BSC			
k1	0.300 REF			
k2	0.450 REF			
k3	0.300 REF			
k4	0.300 REF			
L1	0.30	0.40	0.50	
L2	0.80	0.90	1.00	
L3	0.35	0.45	0.55	
L4	0.15	0.25	0.35	
L5	0.05	0.15	0.25	

GENERIC MARKING DIAGRAM*

BOTTOM VIEW

NNN XXXXXX XXXXXX AYWWZZ NNN = Serial Number

XXXX = Specific Device Code A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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